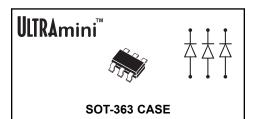
CMKD4448

SURFACE MOUNT
ULTRAmini™
TRIPLE ISOLATED
HIGH SPEED
SILICON SWITCHING DIODES



Central
Semiconductor Corp.

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMKD4448 type contains three (3) Isolated High Speed Silicon Switching Diodes, manufactured by the epitaxial planar process, epoxy molded in an ULTRAmini™ surface mount package, designed for applications requiring high speed switching applications.

MARKING CODE: K48

MAXIMUM RATINGS: $(T_A=25^{\circ}C)$

	SYMBOL		UNITS
Continuous Reverse Voltage	v_{R}	75	V
Peak Repetitive Reverse Voltage	V_{RRM}	100	V
Continuous Forward Current	Ι _Ε	250	mA
Peak Repetitive Forward Current	I _{FRM}	500	mA
Forward Surge Current, tp=1ms	I _{FSM}	4.0	Α
Forward Surge Current, tp=1s	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	325	mW
Operating and Storage			
Junction Temperature	T_{J}, T_{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	385	°C/W

$\textbf{ELECTRICAL CHARACTERISTICS PER DIODE:} \quad (T_{\mbox{\scriptsize A}} = 25^{\circ}\mbox{C unless otherwise noted})$

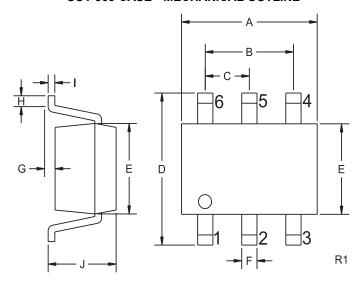
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_{R}	V _R =20V		25	nA
BV_R	I _R =5.0μA	75		V
BV_R	I _R =100μA	100		V
V_{F}	I _F =100mA		1.0	V
C_T	$V_R=0$, f=1 MHz		4.0	pF
t _{rr}	$I_R = I_F = 10$ mA, $R_L = 100\Omega$ Rec. to 1.0mA		4.0	ns

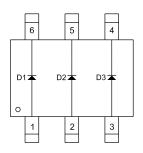


CMKD4448

SURFACE MOUNT ULTRAmini™ TRIPLE ISOLATED HIGH SPEED SILICON SWITCHING DIODES

SOT-363 CASE - MECHANICAL OUTLINE





DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.073	0.085	1.85	2.15			
В	0.0)51	1.30				
С	0.026		0.65				
D	0.075	0.091	1.90	2.30			
Е	0.043	0.055	1.10	1.40			
F	0.006	0.012	0.15	0.30			
G	0.000	0.004	0.00 0.10				
Н	0.010	-	0.25 -				
	0.004	0.010	0.10	0.25			
J	0.031	0.039	0.80	1.00			
SOT-363 (REV: R1)							

LEAD CODE:

- 1) ANODE D1
- 2) ANODE D2
- 3) ANODE D3
- 4) CATHODE D3
- 5) CATHODE D2
- 6) CATHODE D1

MARKING CODE: K48

R3 (2-December 2003)